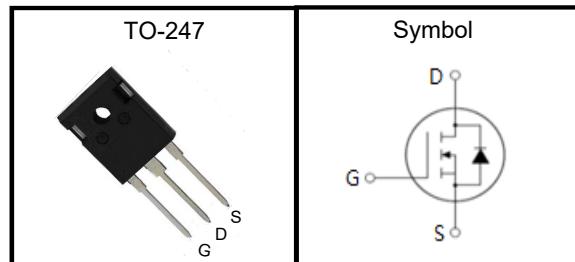


## 600V N Channel Super Junction MOSFET

### Feature

- Fast Recovery Body-Diode
- Very Low FOM ( $R_{DS(on)} \times Q_g$ )
- Extremely low switching los
- Excellent stability and uniformity
- 100% Avalanche Tested

### Pin Description



### Applications

- Switch Mode Power Supply
- Uninterruptible Power Supply
- Power Factor Correction
- TV power

$V_{DSS}$	600	V
$R_{DS(ON)-Typ}$	62	$\text{m}\Omega$
$I_D$	45	A

### Absolute Maximum Ratings

$T_c = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	600	V
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Drain Current - Continuous ( $T_c = 25^\circ\text{C}$ )	45	A
	Drain Current - Continuous ( $T_c = 100^\circ\text{C}$ )	26	A
$I_{DM}^1)$	Drain Current - Pulsed	126	A
$E_{AS}^2)$	Single Pulsed Avalanche Energy	254	$\text{mJ}$
$I_{AR}$	Avalanche Current	1.8	A
$dv/dt$	MOSFET $dv/dt$	100	V/ns
$dv/dt$	Reverse diode $dv/dt$	20	V/ns
$P_D$	Power Dissipation ( $T_c = 25^\circ\text{C}$ )	329	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

### Thermal Resistance Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.38	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	$^\circ\text{C}/\text{W}$

## 600V N Channel Super Junction MOSFET

### Electrical Characteristics $T_j=25^\circ\text{C}$ unless otherwise specified

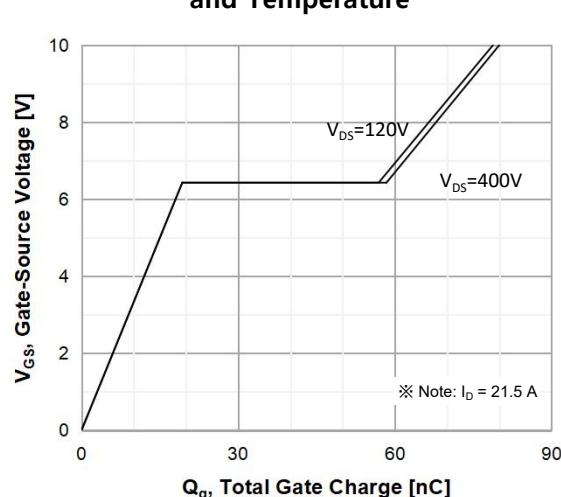
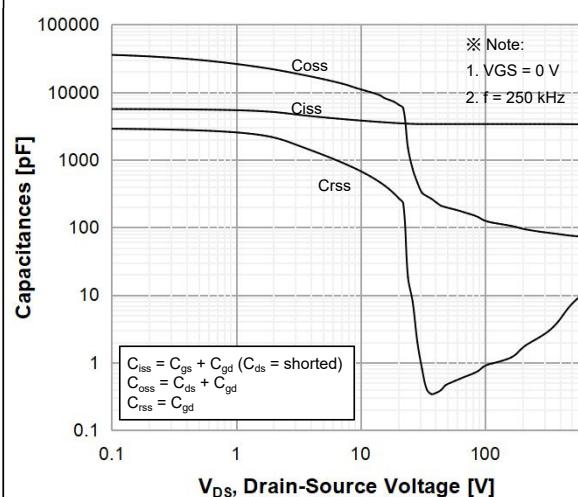
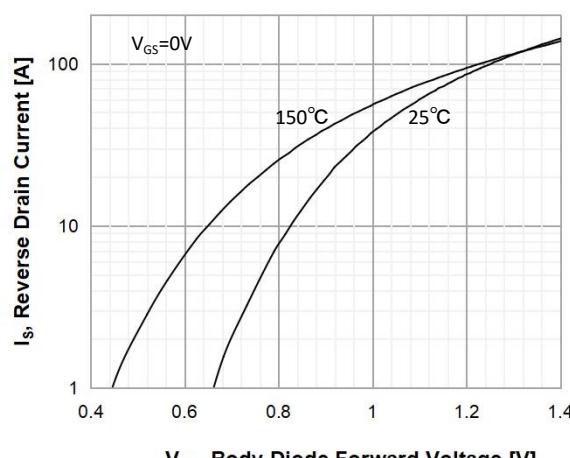
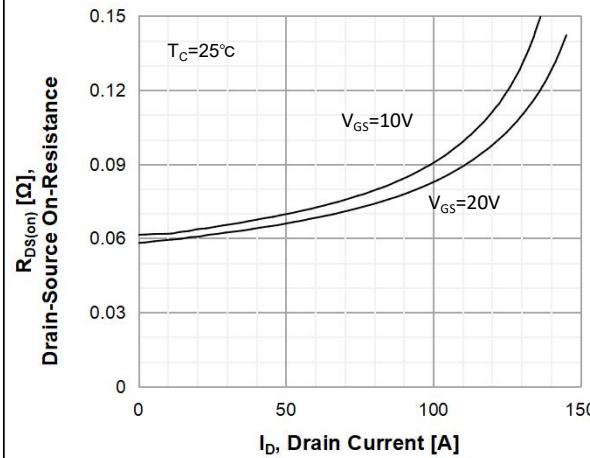
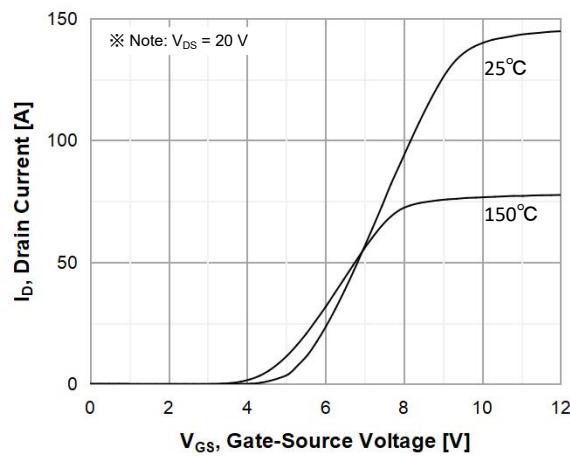
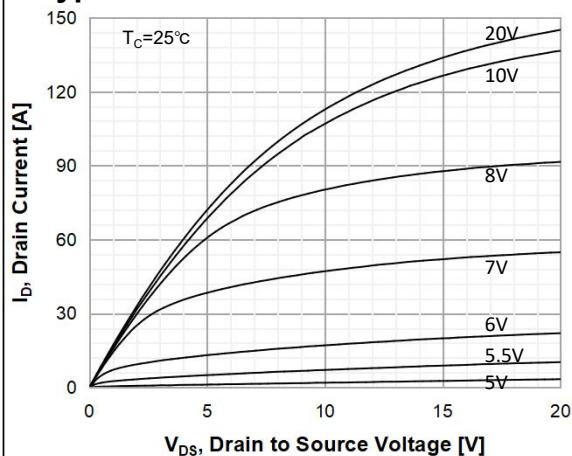
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>On Characteristics</b>						
$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$	3.0	-	5.0	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$ , $I_D = 21.5 \text{ A}$	-	62	75	$\text{m}\Omega$
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_D = 1\text{mA}$	600	-	-	V
$I_{DS(on)}$	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}$ , $V_{GS} = 0 \text{ V}$	-	-	1	$\mu\text{A}$
		$V_{DS} = 480 \text{ V}$ , $T_C = 125^\circ\text{C}$	-	-	10	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS} = \pm 30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	-	-	$\pm 1$	$\mu\text{A}$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 400 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 250\text{KHz}$	-	3360	-	pF
$C_{oss}$	Output Capacitance		-	79	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	10	-	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 400 \text{ V}$ , $I_D = 21.5 \text{ A}$ , $R_G = 4.7\Omega$ (Note 3,4)	-	22	-	ns
$t_r$	Turn-On Rise Time		-	11	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	67	-	ns
$t_f$	Turn-Off Fall Time		-	8	-	ns
$Q_g$	Total Gate Charge	$V_{DS} = 400 \text{ V}$ , $I_D = 21.5 \text{ A}$ , $V_{GS} = 10 \text{ V}$ (Note 3,4)	-	80	-	nC
$Q_{gs}$	Gate-Source Charge		-	19	-	nC
$Q_{gd}$	Gate-Drain Charge		-	39	-	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain-Source Diode Forward Current	-	-	45	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	-	-	126	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}$ , $I_s = 21.5 \text{ A}$	-	-	1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{DD} = 400 \text{ V}$ , $I_s = 21.5 \text{ A}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$	-	175	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	1.5	-	$\mu\text{C}$

**Notes :**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $I_{AS}=6.3\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_j=25^\circ\text{C}$
3. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

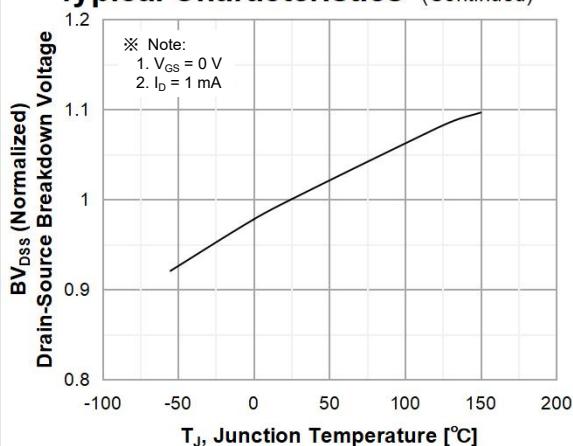
## 600V N Channel Super Junction MOSFET

### Typical Characteristics

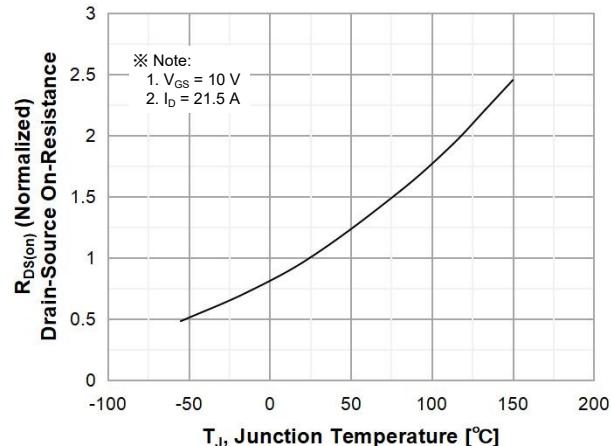


## 600V N Channel Super Junction MOSFET

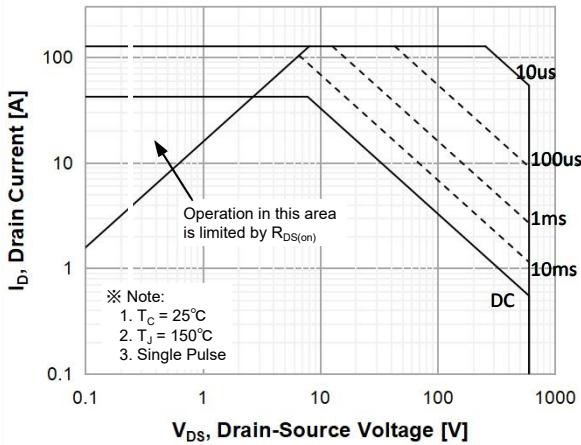
### Typical Characteristics (Continued)



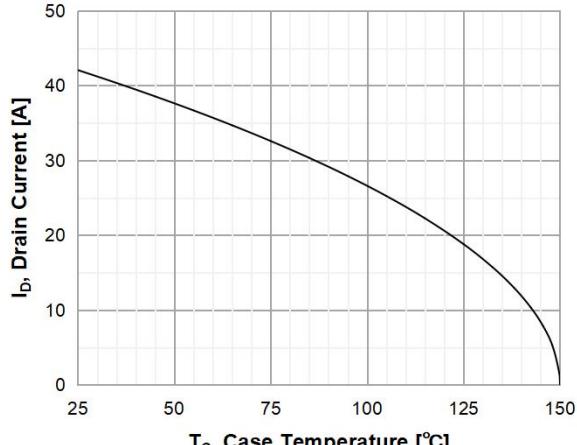
**Figure 7. Breakdown Voltage Variation vs Temperature**



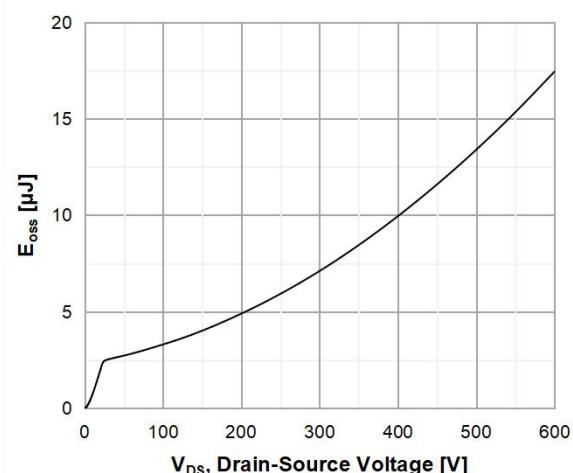
**Figure 8. On-Resistance Variation vs Temperature**



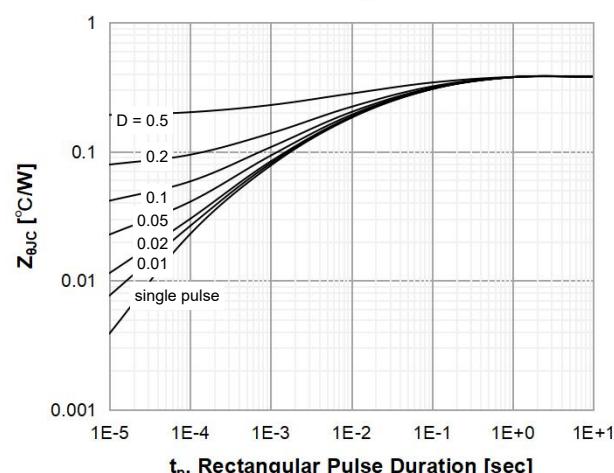
**Figure 9. Maximum Safe Operating Area**



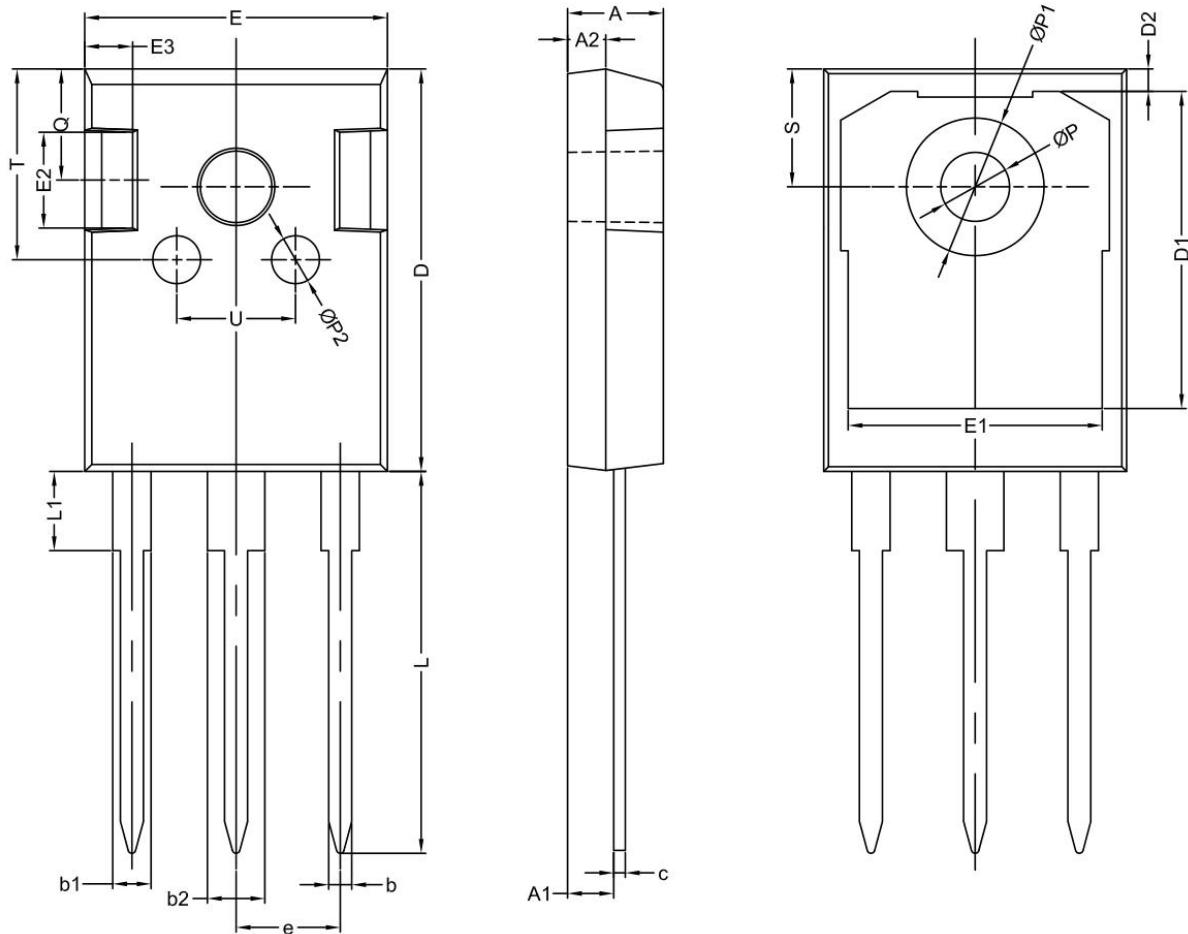
**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11.  $E_{oss}$  vs. Drain to Source Voltage**



**Figure 12. Transient Thermal Response Curve**

**600V N Channel Super Junction MOSFET**
**TO-247 Package Outline Dimensions**


SYMBOL	Mechanical Dimensions/mm			SYMBOL	Mechanical Dimensions/mm			SYMBOL	Mechanical Dimensions/mm		
	MIN	NOM	MAX						MIN	NOM	MAX
A	4.80	5.00	5.20	D	20.80	21.00	21.20	L1	-	4.13	-
A1	2.21	2.41	2.61	D1	-	16.55	-	Ø P	3.5	3.6	3.7
A2	1.90	2.00	2.10	E	15.60	15.80	16.0	Ø P1	-	-	7.40
b	1.10	1.20	1.35	E1		13.3		Ø P2	-	2.50	-
b1	-	2.00	-	E2		5.0		Q	-	5.8	-
b2	-	3.00	-	e	5.44			S	6.05	6.15	6.25
c	0.55	0.60	0.75	L	19.42	19.92	20.42	T	-	10.0	-